

# 74HC573; 74HCT573

Octal D-type transparent latch; 3-state

Rev. 8 — 10 September 2021

Product data sheet

## 1. General description

The 74HC573; 74HCT573 is an 8-bit D-type transparent latch with 3-state outputs. The device features latch enable (LE) and output enable ( $\overline{OE}$ ) inputs. When LE is HIGH, data at the inputs enter the latches. In this condition the latches are transparent, a latch output will change each time its corresponding D-input changes. When LE is LOW the latches store the information that was present at the inputs a set-up time preceding the HIGH-to-LOW transition of LE. A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the latches. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

## 2. Features and benefits

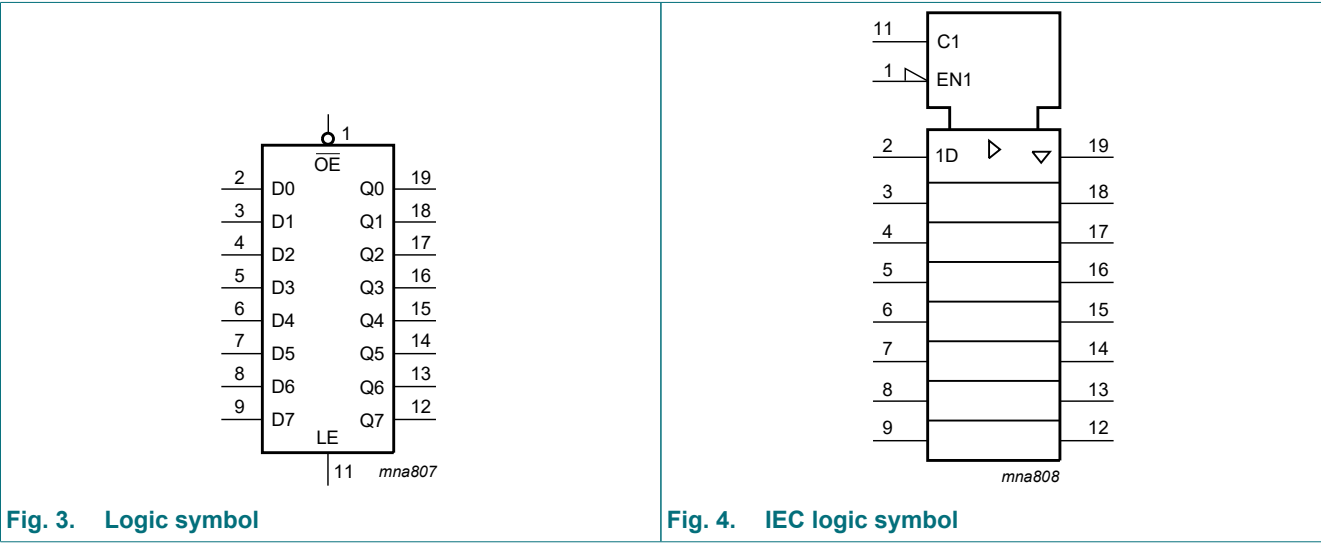
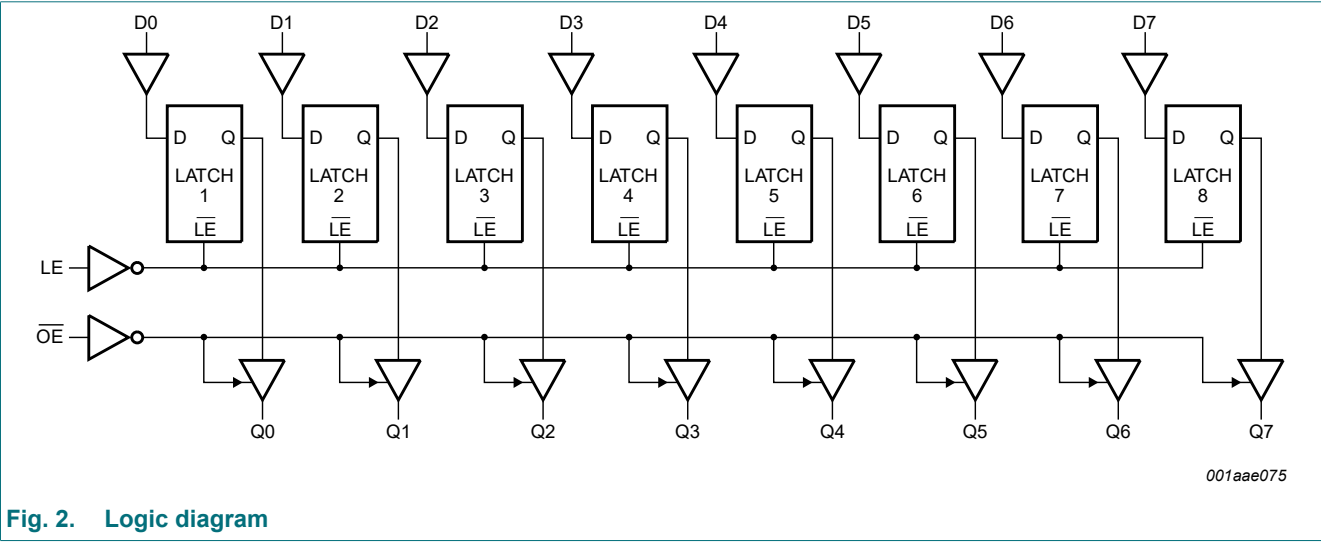
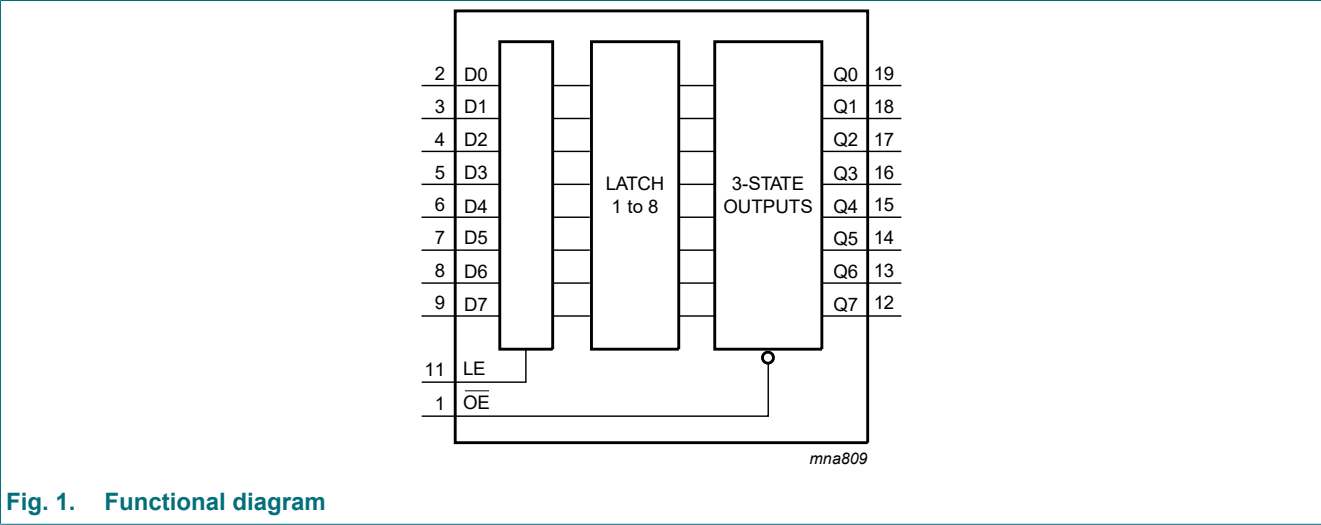
- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Input levels:
  - For 74HC573: CMOS level
  - For 74HCT573: TTL level
- Inputs and outputs on opposite sides of package allowing easy interface with microprocessors
- Useful as input or output port for microprocessors and microcomputers
- 3-state non-inverting outputs for bus-oriented applications
- Common 3-state output enable input
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

## 3. Ordering information

Table 1. Ordering information

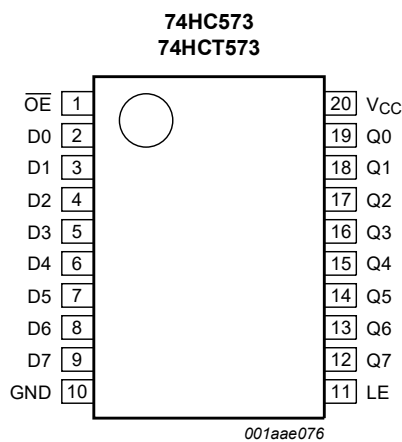
Type number	Package			
	Temperature range	Name	Description	Version
74HC573D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74HCT573D				
74HC573PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74HCT573PW				
74HC573BQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1
74HCT573BQ				

4. Functional diagram

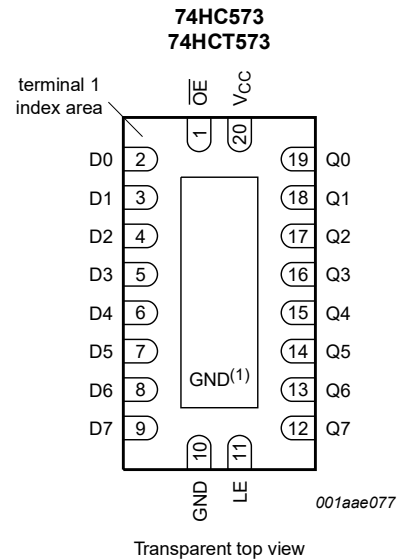


## 5. Pinning information

### 5.1. Pinning



**Fig. 5.** Pin configuration SOT163-1 (SO20) and SOT360-1 (TSSOP20)



(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

**Fig. 6.** Pin configuration SOT764-1 (DHVQFN20)

### 5.2. Pin description

**Table 2.** Pin description

Symbol	Pin	Description
OE	1	3-state output enable input (active LOW)
D0, D1, D2, D3, D4, D5, D6, D7	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
LE	11	latch enable input (active HIGH)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	19, 18, 17, 16, 15, 14, 13, 12	3-state latch output
V <sub>CC</sub>	20	supply voltage

## 6. Functional description

**Table 3. Function table**

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;  
L = LOW voltage level; l = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;  
Z = high-impedance OFF-state.

Operating mode	Control		Input	Internal latches	Output
	OE	LE	Dn		Qn
Enable and read register (transparent mode)	L	H	L	L	L
			H	H	H
Latch and read register	L	L	l	L	L
			h	H	H
Latch register and disable outputs	H	L	l	L	Z
			h	H	Z

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7	V
$I_{IK}$	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$	-	$\pm 20$	mA
$I_{OK}$	output clamping current	$V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$	-	$\pm 20$	mA
$I_O$	output current	$V_O = -0.5\text{ V}$ to $(V_{CC} + 0.5\text{ V})$	-	$\pm 35$	mA
$I_{CC}$	supply current		-	+70	mA
$I_{GND}$	ground current		-70	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	[1]	-	500	mW

- [1] For SOT163-1 (SO20) package:  $P_{tot}$  derates linearly with 12.3 mW/K above 109 °C.  
For SOT360-1 (TSSOP20) package:  $P_{tot}$  derates linearly with 10.0 mW/K above 100 °C.  
For SOT764-1 (DHVQFN20) package:  $P_{tot}$  derates linearly with 12.9 mW/K above 111 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC573			74HCT573			Unit
			Min	Typ	Max	Min	Typ	Max	
$V_{CC}$	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
$V_I$	input voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
$V_O$	output voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
$T_{amb}$	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 2.0\text{ V}$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5\text{ V}$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0\text{ V}$	-	-	83	-	-	-	ns/V

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC573										
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -7.8 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I <sub>OZ</sub>	OFF-state output current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 6.0 V; V <sub>O</sub> = V <sub>CC</sub> or GND	-	-	±0.5	-	±5.0	-	±10.0	µA
I <sub>CC</sub>	supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V	-	-	8.0	-	80	-	160	µA
C <sub>I</sub>	input capacitance		-	3.5	-					pF
74HCT573										
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V								
		I <sub>O</sub> = -20 µA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V								
		I <sub>O</sub> = 20 µA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 6.0 mA	-	0.16	0.26	-	0.33	-	0.4	V

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
$I_I$	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	µA
$I_{OZ}$	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	µA
$I_{CC}$	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	µA
$\Delta I_{CC}$	additional supply current	$V_I = V_{CC} - 2.1$ V; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5$ V to 5.5 V; $I_O = 0$ A								
		per input pin; Dn inputs	-	35	126	-	158	-	172	µA
		per input pin; LE input	-	65	234	-	293	-	319	µA
		per input pin; $\overline{OE}$ input	-	125	450	-	563	-	613	µA
$C_I$	input capacitance		-	3.5	-	-	-	-	-	pF

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit see Fig. 11.

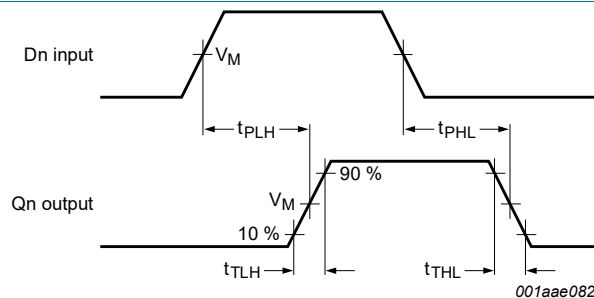
Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC573										
t <sub>pd</sub>	propagation delay	Dn to Qn; see <a href="#">Fig. 7</a> [1]								
		V <sub>CC</sub> = 2.0 V	-	47	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	14	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
		LE to Qn; see <a href="#">Fig. 8</a> [1]								
		V <sub>CC</sub> = 2.0 V	-	50	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	18	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
t <sub>en</sub>	enable time	OE to Qn; see <a href="#">Fig. 9</a> [2]								
		V <sub>CC</sub> = 2.0 V	-	44	140	-	175	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	16	28	-	35	-	42	ns
		V <sub>CC</sub> = 6.0 V	-	13	24	-	30	-	36	ns
t <sub>dis</sub>	disable time	OE to Qn; see <a href="#">Fig. 9</a> [3]								
		V <sub>CC</sub> = 2.0 V	-	55	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	20	30	-	38	-	45	ns
		V <sub>CC</sub> = 6.0 V	-	16	26	-	33	-	38	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
$t_t$	transition time	Qn; see Fig. 7 [4]								
		$V_{CC} = 2.0 \text{ V}$	-	14	60	-	75	-	90	ns
		$V_{CC} = 4.5 \text{ V}$	-	5	12	-	15	-	18	ns
		$V_{CC} = 6.0 \text{ V}$	-	4	10	-	13	-	15	ns
$t_W$	pulse width	LE HIGH; see Fig. 8								
		$V_{CC} = 2.0 \text{ V}$	80	14	-	100	-	120	-	ns
		$V_{CC} = 4.5 \text{ V}$	16	5	-	20	-	24	-	ns
		$V_{CC} = 6.0 \text{ V}$	14	4	-	17	-	20	-	ns
$t_{su}$	set-up time	Dn to LE; see Fig. 10								
		$V_{CC} = 2.0 \text{ V}$	50	11	-	65	-	75	-	ns
		$V_{CC} = 4.5 \text{ V}$	10	4	-	13	-	15	-	ns
		$V_{CC} = 6.0 \text{ V}$	9	3	-	11	-	13	-	ns
$t_h$	hold time	Dn to LE; see Fig. 10								
		$V_{CC} = 2.0 \text{ V}$	5	3	-	5	-	5	-	ns
		$V_{CC} = 4.5 \text{ V}$	5	1	-	5	-	5	-	ns
		$V_{CC} = 6.0 \text{ V}$	5	1	-	5	-	5	-	ns
$C_{PD}$	power dissipation capacitance	$C_L = 50 \text{ pF}$ ; $f = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC}$ [5]	-	26	-	-	-	-	-	pF
<b>74HCT573</b>										
$t_{pd}$	propagation delay	Dn to Qn; see Fig. 7 [1]								
		$V_{CC} = 4.5 \text{ V}$	-	20	35	-	44	-	53	ns
		$V_{CC} = 5 \text{ V}$ ; $C_L = 15 \text{ pF}$	-	17	-	-	-	-	-	ns
		LE to Qn; see Fig. 8 [1]								
		$V_{CC} = 4.5 \text{ V}$	-	18	35	-	44	-	53	ns
		$V_{CC} = 5 \text{ V}$ ; $C_L = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
$t_{en}$	enable time	OE to Qn; see Fig. 9 [2]								
		$V_{CC} = 4.5 \text{ V}$	-	17	30	-	38	-	45	ns
$t_{dis}$	disable time	OE to Qn; see Fig. 9 [3]								
		$V_{CC} = 4.5 \text{ V}$	-	18	30	-	38	-	45	ns
$t_t$	transition time	Qn; see Fig. 7 [4]								
		$V_{CC} = 4.5 \text{ V}$	-	5	12	-	15	-	18	ns
$t_W$	pulse width	LE HIGH; see Fig. 8								
		$V_{CC} = 4.5 \text{ V}$	16	5	-	20	-	24	-	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
$t_{su}$	set-up time	Dn to LE; see Fig. 10								
		$V_{CC} = 4.5 \text{ V}$	13	7	-	16	-	20	-	ns
$t_h$	hold time	Dn to LE; see Fig. 10								
		$V_{CC} = 4.5 \text{ V}$	9	4	-	11	-	15	-	ns
$C_{PD}$	power dissipation capacitance	$C_L = 50 \text{ pF}$ ; $f = 1 \text{ MHz}$ ; $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}$ [5]	-	26	-	-	-	-	-	pF

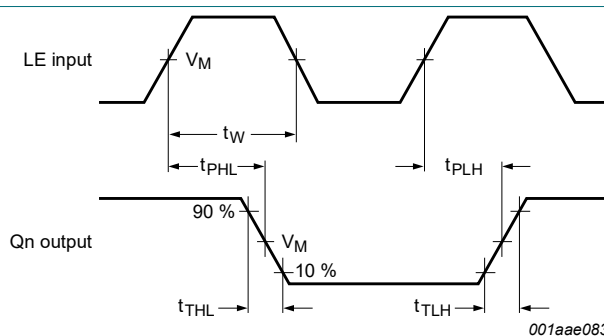
- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  
 [2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .  
 [3]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .  
 [4]  $t_i$  is the same as  $t_{THL}$  and  $t_{TLH}$ .  
 [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  
 $f_o$  = output frequency in MHz;  
 $C_L$  = output load capacitance in pF;  
 $V_{CC}$  = supply voltage in V;  
 $N$  = number of inputs switching;  
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 10.1. Waveforms and test circuit



Measurement points are given in Table 8.

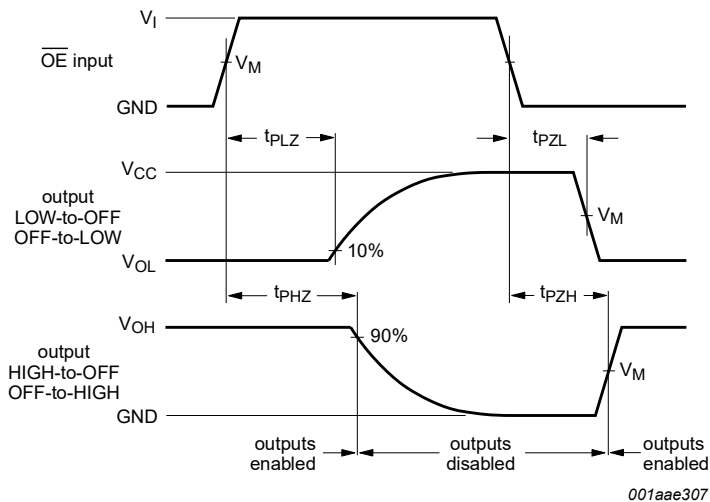
**Fig. 7. Propagation delay data input (Dn) to output (Qn) and output transition time**



Measurement points are given in Table 8.

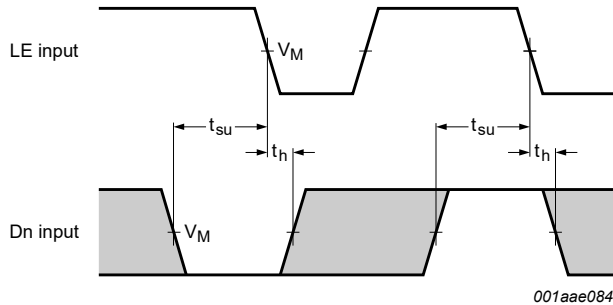
**Fig. 8. Pulse width latch enable input (LE), propagation delay latch enable input (LE) to output (Qn) and output transition time**





Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Fig. 9. Enable and disable times



Measurement points are given in [Table 8](#).  
The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 10. Set-up and hold times for data input (Dn) to latch input (LE)

Table 8. Measurement points

Type	Input	Output
	$V_M$	$V_M$
74HC573	$0.5V_{CC}$	$0.5V_{CC}$
74HCT573	1.3 V	1.3 V

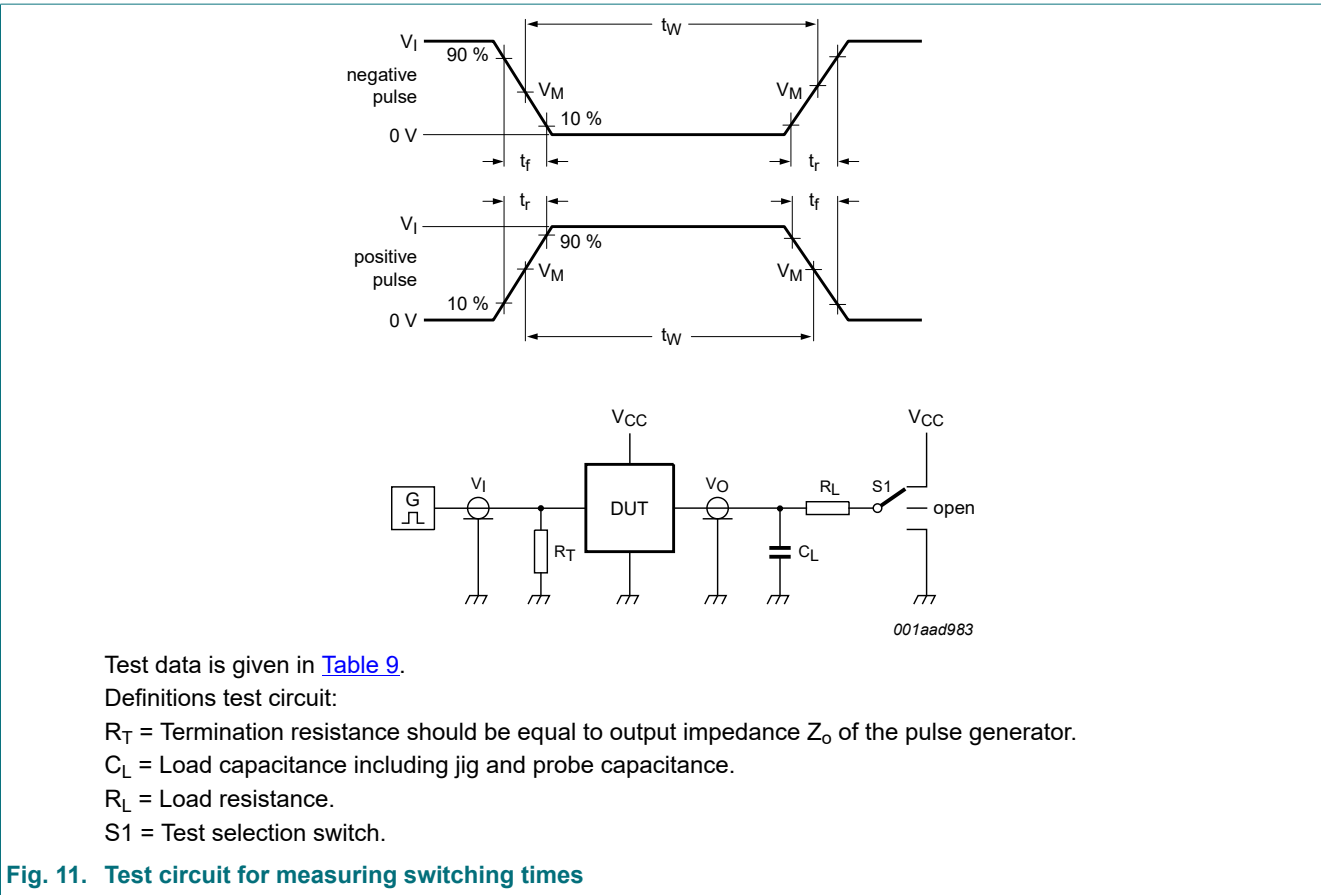


Table 9. Test data

Type	Input		Load		S1 position		
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PHL}, t_{PLH}$	$t_{PZH}, t_{PHZ}$	$t_{PZL}, t_{PLZ}$
74HC573	$V_{CC}$	6 ns	15 pF, 50 pF	1 k $\Omega$	open	GND	$V_{CC}$
74HCT573	3 V	6 ns	15 pF, 50 pF	1 k $\Omega$	open	GND	$V_{CC}$

11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

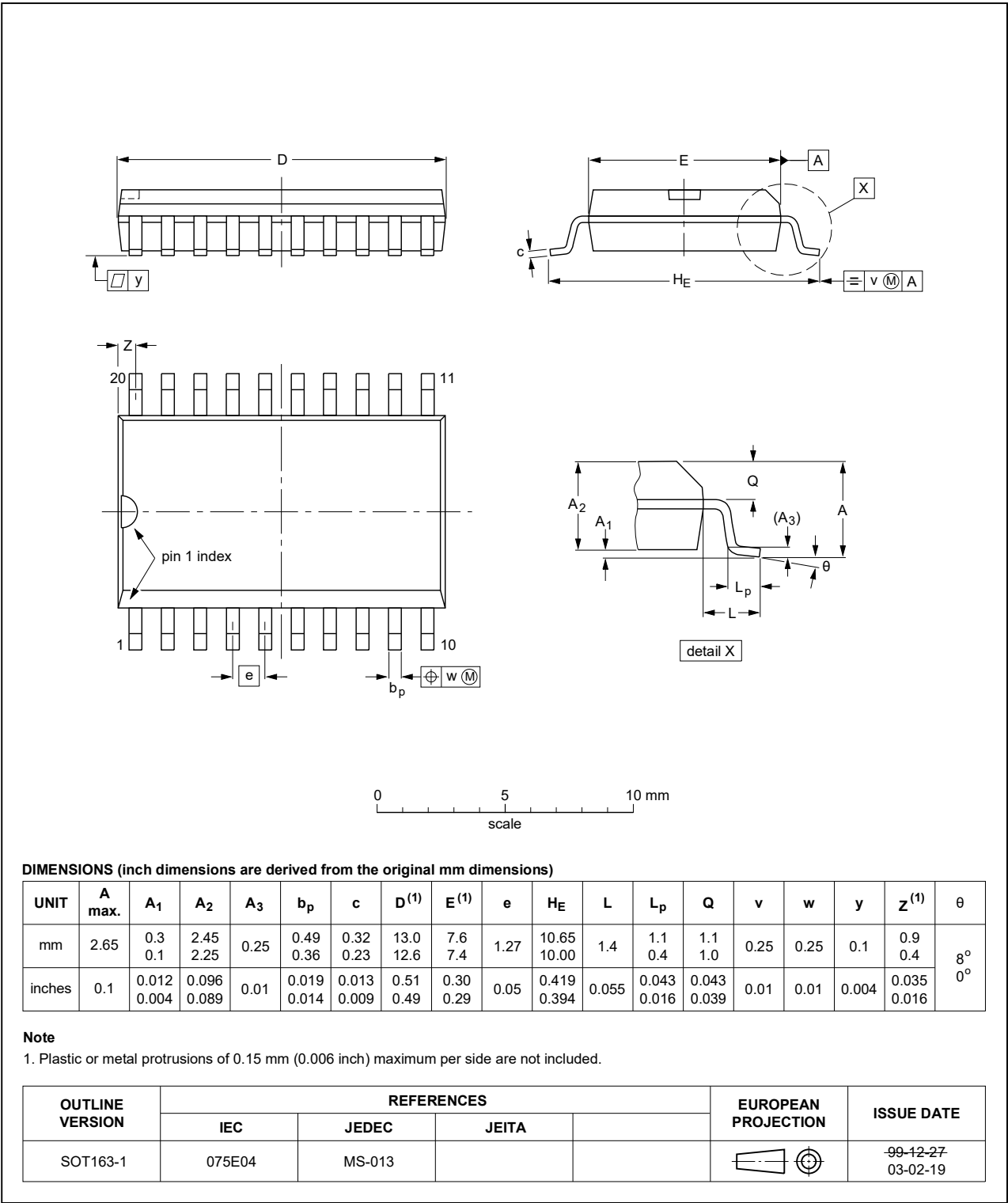


Fig. 12. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Fig. 13. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;  
20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

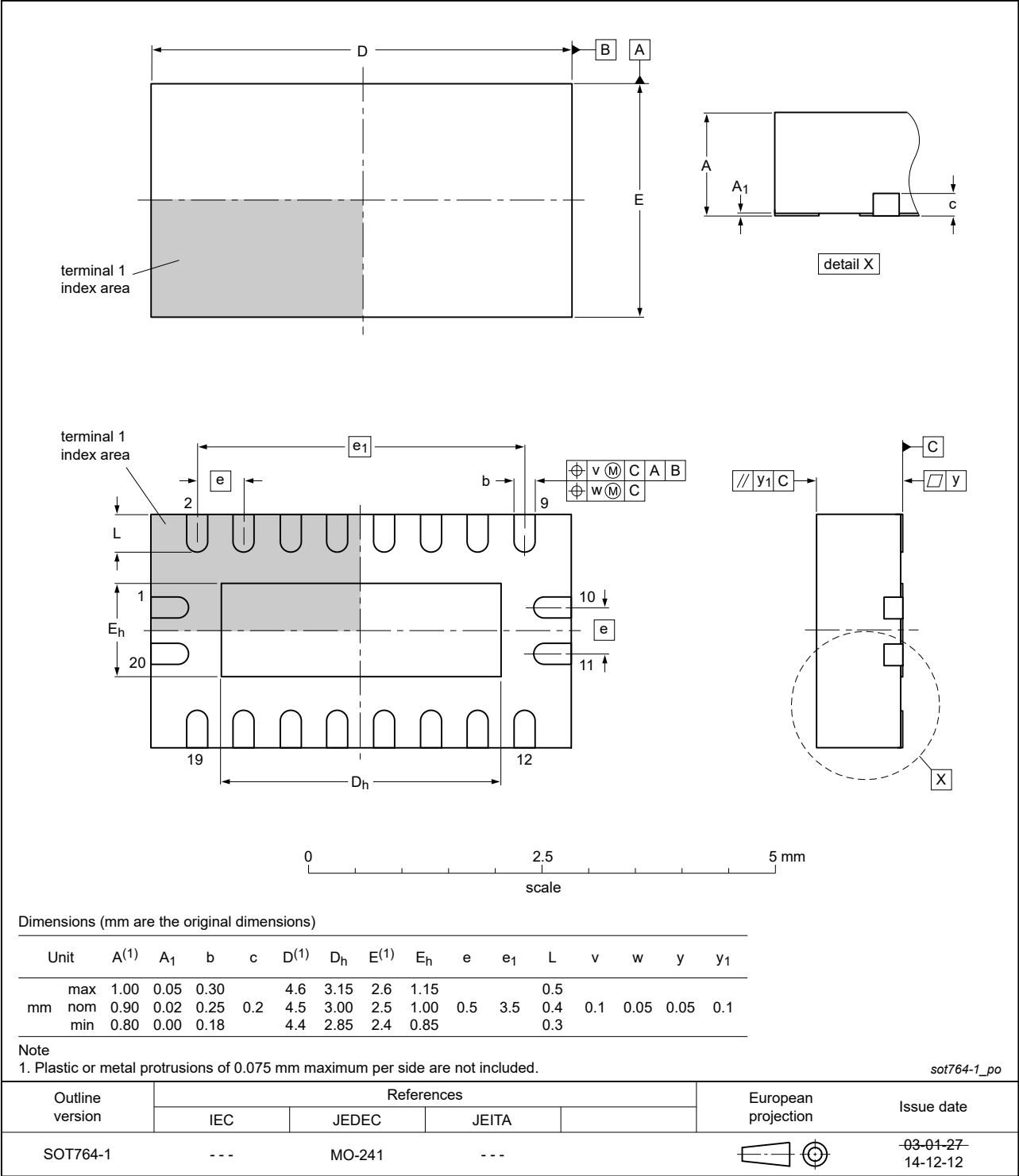


Fig. 14. Package outline SOT764-1 (DHVQFN20)

## 12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT573 v.8	20210910	Product data sheet	-	74HC_HCT573 v.7
Modifications:	<ul style="list-style-type: none"> <li>Type numbers 74HC573DB and 74HCT573DB (SO339-1/SSOP20) removed.</li> <li><a href="#">Section 2</a> updated.</li> <li><a href="#">Section 7</a>: Derating values for <math>P_{tot}</math> have been updated.</li> </ul>			
74HC_HCT573 v.7	20160304	Product data sheet	-	74HC_HCT573 v.6
Modifications:	<ul style="list-style-type: none"> <li>Type numbers 74HC573N and 74HCT573N (SOT146-1) removed.</li> </ul>			
74HC_HCT573 v.6	20150126	Product data sheet	-	74HC_HCT573 v.5
Modifications:	<ul style="list-style-type: none"> <li><a href="#">Table 7</a>: Power dissipation capacitance condition for 74HCT573 is corrected.</li> </ul>			
74HC_HCT573 v.5	20120815	Product data sheet	-	74HC_HCT573 v.4
Modifications:	<ul style="list-style-type: none"> <li>Alternative descriptive title corrected (errata).</li> </ul>			
74HC_HCT573 v.4	20120806	Product data sheet	-	74HC_HCT573 v.3
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
74HC_HCT573 v.3	20060117	Product data sheet	-	74HC_HCT573_CNV v.2
74HC_HCT573_CNV v.2	19901201	Product specification	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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